TACT Switch[™] Low Contact Resistance (Surface Mount Type)

SKPM Series

RoHS

Detector

Push

Slide

Rotary

Encoders

Power

Sharp Feeling

Soft Feeling

Snap-in Туре Surface

Mount Type

Radial

Туре

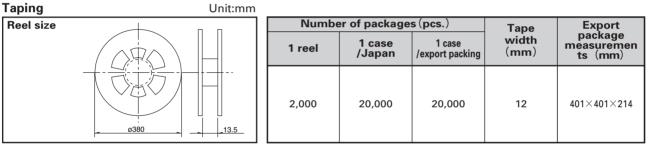
Soft feeling with metal contact provide low contact resistance.



Product Line

Prod	luct No.	Operating force	Operating direction	Travel (mm)	Rating (max.)	Rating (min.)	Operating life (5mA 5V DC)	Initial contact resistance	Minimum order unit (pcs.)	Dual-in-line Package Type
SKPM	1AME010	1.57N		1.3	50mA 16V DC	10µA 1V DC	100,000cycles	100mΩ max.	2,000	TACT Switch [™]
SKPM	IANE010	1.96N								
SKPIV	/IAPE010	2.45N	Vertical							Custom-
SKPIV	/IBHE010	ЗN								Products

Packing Specifications



Dimensions Unit:mm PC board land dimensions Style (Viewed from switch mounting face) 6.6 5.9 5 4.9 4 ŝ 3.5

Circuit Diagram

Notes

1. For ϕ 330mm diameter reel requirements, please contact us.

2. Please place purchase orders per minimum order unit N

(integer).



Automotive

Use

List of Varieties

Soft Feeling Type

	Series		SKEG	SKEG	SKEY	SKPF	SKPM	SKPG	SKPL	SKPD
Photo										
	Туре		,	Sna	p–in	,	Surface mount Radial			dial
	Feature	s	_	Horizontal High operation type force travel		Low contact resistance	_	Round terminal and low contact resistance		
Ope	Vertical Horizontal		•	_	•	•	•	•	•	•
Operating			_	•						I
		w		7.5		8	5.9	6.6		
	nsions nm)	D	6	9.9	7.8	9	6	6.3	- ¢6.45	□7.8
		н	7	7.3	5	10	5		5	I
Conta		t		Car	bon		Silver	Carbon	Silver	Carbon
1N Operation force coverage		↓ ↓	Ĵ	Ţ	Ĵ	Ĵ	Ĵ	\$	Î	
		5N								
Ground terminal Operating temperature range										
		-20°C to +70°C −40°C to +90°C								
Elec	Insul resist		100MΩ min. 100V DC SKEY/PD : 50MΩ min. 100V DC							
Electrical	Volt	age oof			S		for 1min. JV AC for 1min.			
	Vibra	ation	10 to 55 to 10Hz/min., the amplitude is 1.5mm for all the frequencies, in the 3 direction of X, Y and Z for 2hours respectively							
Durability	Lifet	ime	Shall be in accordance with individual specifications.							
Env	Co	ld	−30±2℃ for 96h							
1.5		heat	80±2℃ for 96h							
vironm	Dry			t 60±2℃, 90 to 95%RH for 96h						
Environmental	Dry Damp	heat			6	60±2℃, 90 to 9	95%RH for 96	511		

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Detector

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Dual-in-line Package Type

TACT Switch™

Custom-

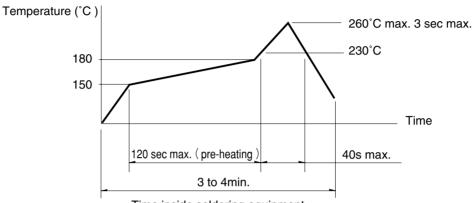
Products

Soldering Conditions

Condition for Reflow

Available for Surface Mount Type.

- 1. Heating method: Double heating method with infrared heater.
- 2. Temperature measurement: Thermocouple 0.1 to 0.2 ϕ CA (K) or CC (T) at solder joints (copper foil surface). A heat resistive tape should be used to fix thermocouple.
- 3. Temperature profile



Time inside soldering equipment

Notes

- 1. The above temperature shall be measured of the top of switch. There are cases where the PC board's temperature greatly differs from that of the switch, depending on the material, size, thickness of PC boards and others. The above-stated conditions shall also apply to switch surface temperatures.
- 2. Soldering conditions differ depending on reflow soldering machines. Prior verification of soldering condition is highly recommended.

Conditions for Auto-dip

Available for Snap-in Type and Radial Type (Except SKHJ, SKHL, SKQJ, SKQK, SKEG series)

ltems	Condition			
Flux built-up	Mounting surface should not be exposed to fluk			
Preheating temperature	Ambient temperature of the soldered surface of PC board. 100°C max.			
Preheating time	60s max.			
Soldering temperature	260°C max.			
Duration of immersion	5s max.			
Number of soldering	2times max.			

Manual Soldering (Except SKRT Series)

ltems	Condition			
Soldering temperature	350℃max.			
Duration of soldering	3s max.			
Capacity of soldering iron	60W max.			

Sharp Feeling Soft Feeling Snap-in Type Surface Mount Type Radial Type

Notes

- 1. Consult with us for availability of TACT Switch[™] washing.
- 2. Prevent flux penetration from the top side of the TACT Switch[™].
- 3. Switch terminals and a PC board should not be coated with flux prior to soldering.
- 4. The second soldering should be done after the switch is stable with normal temperature.
- 5. Use the flux with a specific gravity of min 0.81.
- (EC-19S-8 by TAMURA Corporation, or equivalents.)